

TERMINAL (ENTER 1, 2, 3, 4, OR ?): 3

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=> s "methyl trimethoxysilane" or methyltrimethoxysilane

277466 "METHYL"
3079 "TRIMETHOXYSILANE"
201 "METHYL TRIMETHOXYSILANE"
("METHYL" (W) "TRIMETHOXYSILANE")

L1 1635 METHYLTRIMETHOXYSILANE
 1782 "METHYLTRIMETHOXYSILANE" OR METHYLTRIMETHOXYSILANE

=> s 11(p)"aluminum hydroxide"

318351 "ALUMINUM"
181628 "HYDROXIDE"
9544 "ALUMINUM HYDROXIDE"
 ("ALUMINUM"(W)"HYDROXIDE")

L2 10 L1(P)"ALUMINUM HYDROXIDE"

=> d cit 1-

1. 5,804,631, Sep. 8, 1998, Curable organosiloxane compositions and semiconductor devices; Katsutoshi Mine, et al., 524/440; 257/783; 427/387; 524/780, 785; 528/15, 16, 17 [IMAGE AVAILABLE]
2. 5,708,076, Jan. 13, 1998, Room temerature-curable organopolysiloxane composition; Yuichi Tsuji, et al., 524/788, 403, 425, 437, 785, 786; 528/15 [IMAGE AVAILABLE]
3. 5,684,110, Nov. 4, 1997, Silicone rubber composition for formed-in-place gaskets; Naoji Kawamura, 528/15, 16, 17, 31, 32, 33 [IMAGE AVAILABLE]
4. 5,683,501, Nov. 4, 1997, Compound fine particles and composition for forming film; Daijo Tomihisa, et al., 106/491, 287.1, 287.11, 287.12, 287.13, 287.14, 287.16, 287.17, 287.19, 447, 490 [IMAGE AVAILABLE]
5. 5,625,022, Apr. 29, 1997, Curable organopolysiloxane composition; Masayuki Onishi, 528/15; 525/478, 479; 528/16, 17 [IMAGE AVAILABLE]
6. 5,504,174, Apr. 2, 1996, Curable organopolysiloxane composition with condensation reaction curing and addition reaction curing; Masayuki Onishi, 528/15; 525/478; 528/17 [IMAGE AVAILABLE]
7. 5,247,011, Sep. 21, 1993, Room temperature-curable organopolysiloxane composition; Yuichi Tsuji, et al., 524/731, 785, 786, 788, 863, 864 [IMAGE AVAILABLE]
8. 5,071,883, Dec. 10, 1991, Process for the production of expanded particles of a polyolefin resin; Hideki Kuwabara, et al., 521/60, 56, 58 [IMAGE AVAILABLE]
9. 4,782,112, Nov. 1, 1988, Silicone water-based emulsion composition; Hidetoshi Kondo, et al., 524/837, 861, 862 [IMAGE AVAILABLE]
10. 4,476,155, Oct. 9, 1984, High voltage insulators; Randolph G. Niemi, 427/58; 174/137A, 137B; 252/573; 427/387 [IMAGE AVAILABLE]

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